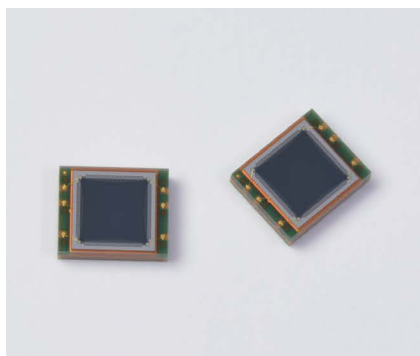


Two-dimensional PSD

S15534



Surface mount type, high-accuracy position sensitive detector

The S15534 is a surface mount type two-dimensional PSD with excellent position detection characteristics. It is smaller than the conventional S5990-01.

Features

- COB type
- Excellent position detectability
- Small package: 7.21 × 5.96 × 1.5^t mm
- Compatible with lead-free solder reflow

Applications

- Light spot detection
- Pointing device
- Various types of position detection

Options (sold separately)

- Signal processing circuit for 2-D PSD **C4674-01**

Structure

Parameter	Symbol	Specification	Unit
Photosensitive area	A	4 × 4	mm
Package	-	Glass epoxy	-
Window material	-	Silicone resin	-

Absolute maximum ratings (Ta=25 °C)

Parameter	Symbol	Value	Unit
Reverse voltage	V _R max	20	V
Operating temperature*1	T _{opr}	-20 to +60	°C
Storage temperature*1	T _{stg}	-20 to +80	°C
Soldering temperature	T _{sol}	260 (3 times)*2	°C

*1: No dew condensation. When there is a temperature difference between a product and the surrounding area in high humidity environments, dew condensation may occur on the product surface. Dew condensation on the product may cause deterioration in characteristics and reliability.

*2: Reflow soldering, JEDEC J-STD-020 MSL 3, see P.5

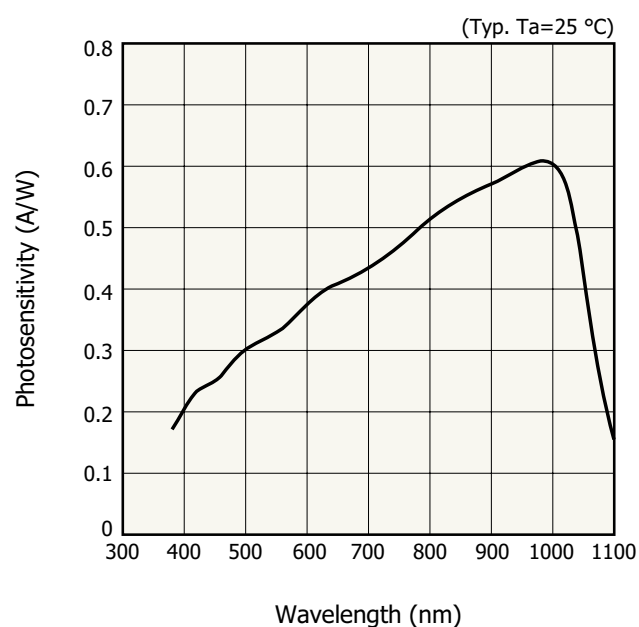
Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.

Electrical and optical characteristics (Ta=25 °C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Spectral response range	λ		-	380 to 1100	-	nm
Peak sensitivity wavelength	λ_p		-	980	-	nm
Photosensitivity	S	$\lambda = \lambda_p$	-	0.6	-	A/W
Interelectrode resistance	Rie	Vb=0.1 V	5	7	15	k Ω
Position detection error	E	$\lambda = 900$ nm, VR=5 V light spot: $\phi 0.2$ mm*3	-	± 70	± 150	μ m
Saturation photocurrent	Ist	$\lambda = 900$ nm, VR=5 V RL=1 k Ω	-	500	-	μ A
Dark current	ID	VR=5 V	-	0.5	10	nA
Rise time	tr	VR=5 V, RL=1 k Ω $\lambda = 900$ nm	-	1	-	μ s
Terminal capacitance	Ct	VR=5 V, f=10 kHz	-	70	-	pF
Position resolution	ΔR	Io=1 μ A, B=1 kHz*3	-	0.7	-	μ m

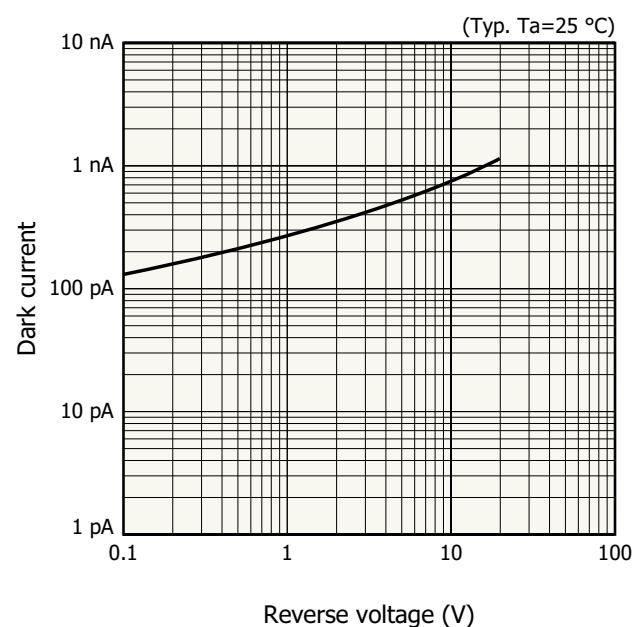
*3: Specified within a circle that is 80% of the photosensitive area. Recommended light spot size: $\phi 0.2$ mm or more

Spectral response



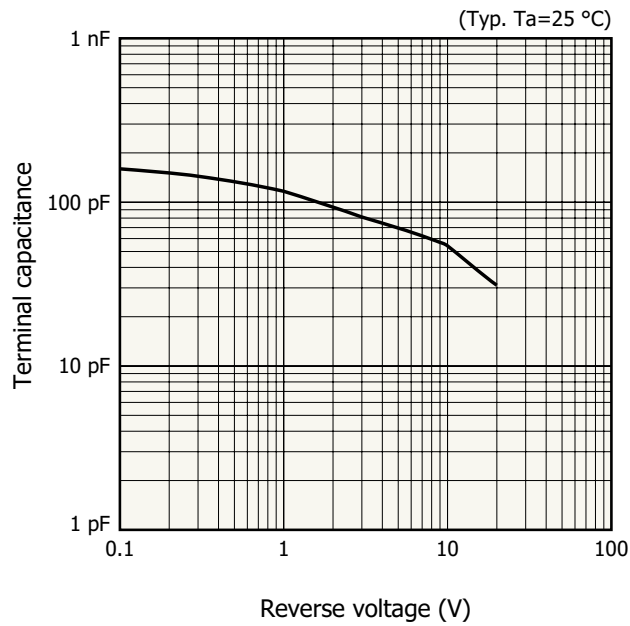
KPSDB0128EA

Dark current vs. reverse voltage

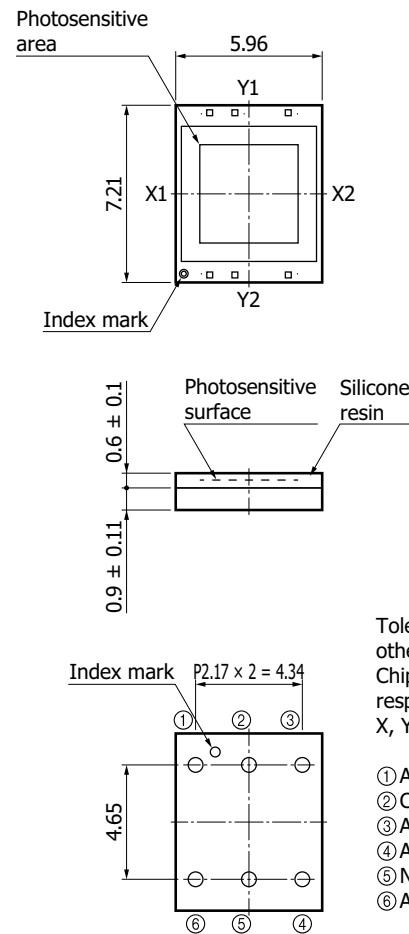


KPSDB0129EA

Terminal capacitance vs. reverse voltage



Dimensional outline (unit: mm)



KPSDA0068EA

Conversion formula of spot light position on the PSD

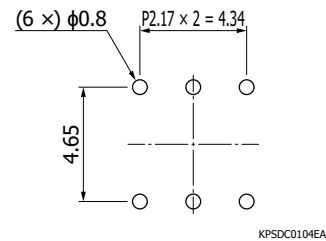
Output signals (photocurrent) I_{X1}, I_{X2}, I_{Y1}, I_{Y2} obtained from electrodes and the light spot position *x*, *y* can be found by the following formula.

$$\frac{(I_{X2} + I_{Y1}) - (I_{X1} + I_{Y2})}{I_{X1} + I_{X2} + I_{Y1} + I_{Y2}} = \frac{2x}{L_X}$$

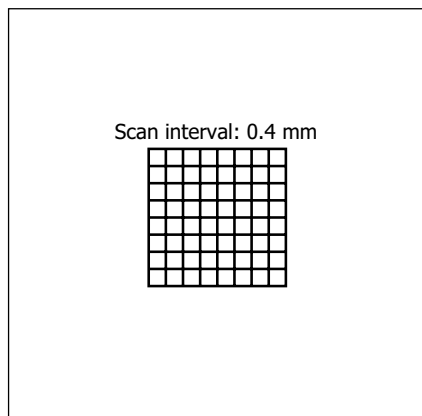
$$\frac{(I_{X2} + I_{Y2}) - (I_{X1} + I_{Y1})}{I_{X1} + I_{X2} + I_{Y1} + I_{Y2}} = \frac{2y}{L_Y}$$

I_{X1} : Output signal from electrode X₁
I_{X2} : Output signal from electrode X₂
I_{Y1} : Output signal from electrode Y₁
I_{Y2} : Output signal from electrode Y₂
x, *y* : Position coordinate of light spot
L_X, L_Y: Resistance length (4.5 mm)

Recommended land pattern (unit: mm)



Example of position detectability ($T_a=25\text{ }^{\circ}\text{C}$, $\lambda=900\text{ nm}$, light spot size: $\phi 0.2\text{ mm}$)



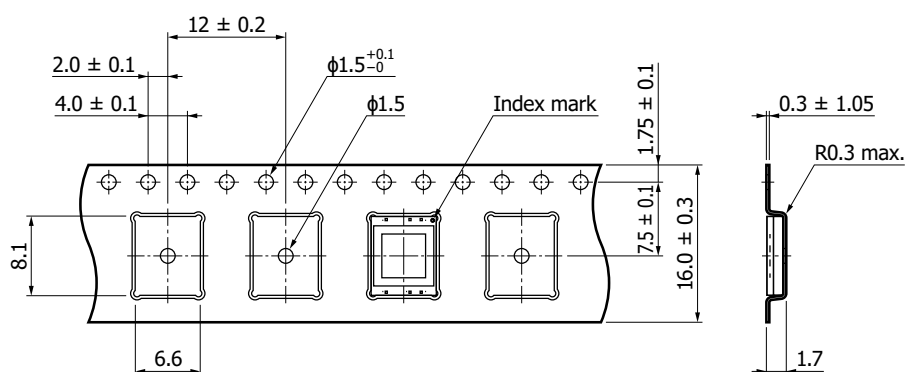
KPSDC0064EA

Standard packing specifications

■ Reel (conforms to JEITA ET-7200)

Outer diameter	Hub diameter	Tape width	Material	Electrostatic characteristics
$\phi 330\text{ mm}$	$\phi 100\text{ mm}$	16 mm	PS	Conductive

■ Embossed tape (unit: mm, material: PS, conductive)



KPSDC0105EA

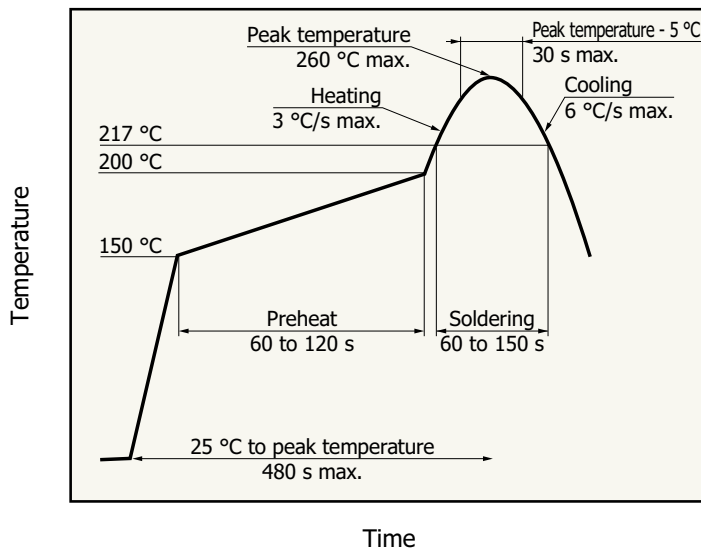
■ Packing quantity

500 pcs/reel

■ Packing state

Reel and desiccant in moisture-proof packaging (vacuum-sealed)

Recommended reflow soldering conditions



- After unpacking, store in an environment at a temperature of 5 to 30 °C and a humidity 60% or less, and perform reflow soldering within 168 hours.
- The effect that the product receives during reflow soldering varies depending on the circuit board and reflow oven that are used. When you set reflow soldering conditions, check that problems do not occur in the product by testing out the conditions in advance.

KSPD80419EA

Baking

If more than 12 months have passed in the unopened state, or storage conditions are exceeded after opening the package, baking is required to remove moisture before reflow soldering. For the baking, refer to "Precautions / Surface mount type products" in the related information.

Recommended baking conditions

Temperature: 120 °C, 3 hours, up to twice

Note: Before setting the baking conditions, perform experiments to confirm that no problems occur with the product.

Related information

www.hamamatsu.com/sp/ssd/doc_en.html

Precautions

- Disclaimer
- Precautions / Surface mount type products

Catalogs

- Technical note / PSD

Information described in this material is current as of January 2025.

Product specifications are subject to change without prior notice due to improvements or other reasons. This document has been carefully prepared and the information contained is believed to be accurate. In rare cases, however, there may be inaccuracies such as text errors. Before using these products, always contact us for the delivery specification sheet to check the latest specifications.

The product warranty is valid for one year after delivery and is limited to product repair or replacement for defects discovered and reported to us within that one year period. However, even if within the warranty period we accept absolutely no liability for any loss caused by natural disasters or improper product use. Copying or reprinting the contents described in this material in whole or in part is prohibited without our prior permission.

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